



TSM-116-02-S-DV-LC



TSM-121-01-T-SV



(2.54 mm) .100"

SMT .025" SQ POST HEADER

Board Mates:

SSW, SSQ, SSM, BSW, ESW, ESQ, BCS, SLW, CES, HLE

Cable Mates:

IDSS, IDSD

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TSM

Insulator Material:

Black Liquid Crystal Polymer

Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over 50 μ" (1.27 μm) Ni

Operating Temp Range:

-55 °C to +105 °C with Tin;

-55 °C to +125 °C with Gold

Voltage Rating:

475 VAC -SV/-DV mated with BCS or SSM

RoHS Compliant: Yes

RoHS Compliant: Yes

MATES	CURRENT RATING (PER PIN)
TSM/SSW	4.7 A
TSM/SSM	5.4 A
TSM/HLE	4.1 A
2 PINS POWERED	

PROCESSING

Lead-Free Solderable: Yes

-DH/-SH Lead Coplanarity: (0.15 mm) .006" max (02-36)*

-DV/-SV Lead Coplanarity: (0.10 mm) .004" max (02-05)

(0.13 mm) .005" max (06-10)*

(0.15 mm) .006" max (11-36)*

*(.004" stencil solution may be available; contact IPG@samtec.com)

RECOGNITIONS

For complete scope of recognitions see

www.samtec.com/quality

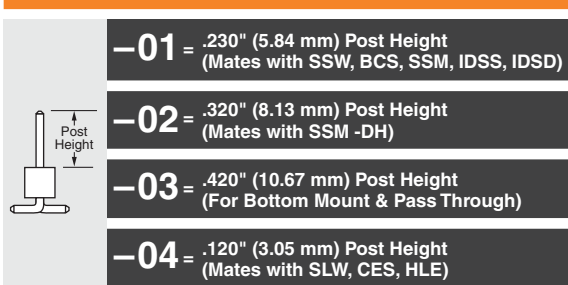


ALSO AVAILABLE (MOQ Required)

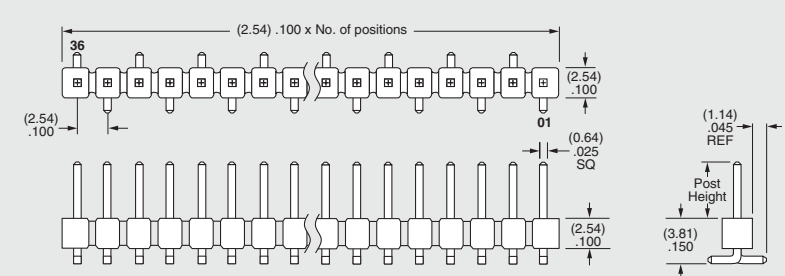
- Edge Mount and Locking Clips for -SV
- Solder Locks for -DH and Shrouds for -DV
- Other platings

Note: Some lengths, styles and options are non-standard, non-returnable.

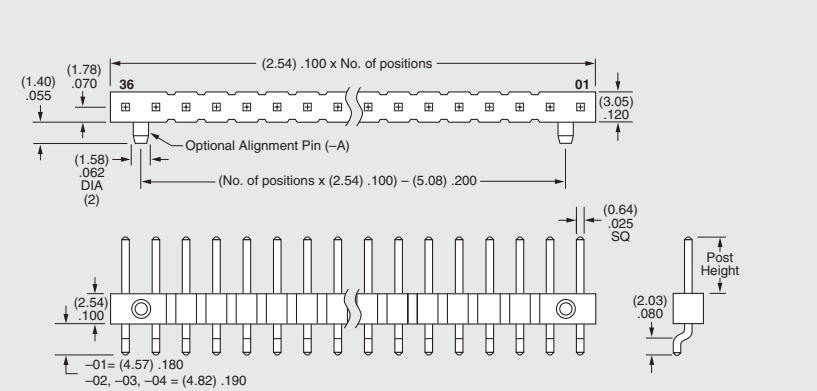
TSM	1	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	ROW OPTION
		02 thru 36		-F = Gold flash on post, Matte Tin on tail	
				-L = 10 μ" (0.25 μm) Gold on post, Matte Tin on tail	
				-S = 30 μ" (0.76 μm) Gold on post, Matte Tin on tail	
				-T = Matte Tin	



-SV = Single Row Vertical Pin



-SH = Single Row Horizontal Pin



Due to technical progress, all designs, specifications and components are subject to change without notice.



TSM-126-02-L-DH-K

TSM-115-01-T-SH-A



TSM-110-01-T-DV

TSM SERIES

OTHER OPTIONS

-A

= Alignment Pin metal or plastic at Samtec discretion (Not available with -TM or -MT) (02 positions min.) (Not available with -LC)

-LC

= Locking Clip (Not available with -TM) (3 positions min.) (Not available with -A) (Manual placement required)

-K

= (6.50 mm) .256" DIA Polyimide Film Pick & Place Pad (-SH: 4 positions minimum without -TR; 2 & 3 positions available with -TR) (-DH: 4 positions minimum without -TR)

-“XXX”

= Polarized Position

-P

= Plastic Pick & Place Pad (-DV: 4 positions minimum without -TR; 2 & 3 positions available with -TR) (-SH: 4 positions minimum without -TR; 2 & 3 positions available with -TR) (-DH: 5 positions minimum without -TR) (-SV: 4 positions minimum without -TR; 2 & 3 positions available with -TR)



-SV



-SH & -DH

-TR

= Tape & Reel Packaging -SV = 02-22 positions -DV = 02-28 positions -SH = 02-30 positions -DH = 02-29 positions

Not available with -MT or -TM

-DV

= Double Row Vertical Pin



-TM

= Triple Row Vertical Mixed Technology (Style -01 only)

02 thru 30 positions only



-DH

= Double Row Horizontal Pin (Style -01, -02 or -03 only)



-MT

= Mixed Technology Pin (Style -01, -02 or -03 only)



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WWW.SAMTEC.COM

All parts within this catalog are built to Samtec's specifications. Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.

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